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NO: DSFN0151E001A

SPECIFICATION OF MODULE

MODULE NO: ZC-015101-0101 RoHS Complaint Product

Customer Approval:	
☐ Accept	☐ Reject

ZOYO FOCUS	SIGNATURE	DATE
PREPARED BY	JYQ	2024.04.19
CHECKED BY	YG	2024.04.19
APPROVED BY		

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Sample Version	Doc. Version	DATE	DESCRIPTION	CHECKED BY
01	A	2024.04.19	First Release.	YG





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1. GENERAL DESCRIPTION:

<u>ZC</u> - <u>0151</u> <u>01</u> - <u>0101</u>

(1)

Q

(1) ZOYO Focus Brand

2 Display size: 1.51inch

3 LCM serial NO.

4 serial NO.

2. MECHANICAL SPECIFICATIONS:

ITEM	SPECIFICATION	Remark
Module Outline Dimension(W x H x D)(mm)	40.71(W)×40.81(H)×0.82(D)	Excluding Cover lens
Active Area(mm)	38.207(H)×38.207(V)	
Pixel Pitch (um)	81.99(H)X81.99(V)	
Resolution(dot)	466(H)×466(V)	-
Driver IC(Type)	CH13613-SSS32	-
Display Mode	AMOLED	-
Interface	MIPI&SPI	
Color Depth	16.7M	-
Luminance	600 (TYP.)	cd/m²
Viewing Direction	ALL	-

^{*}See attached drawing for details.

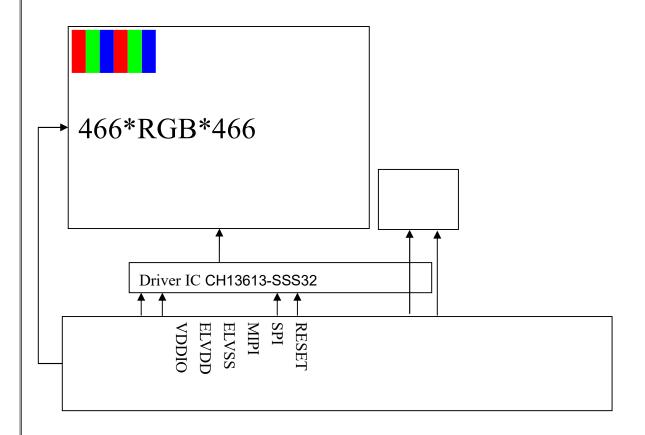


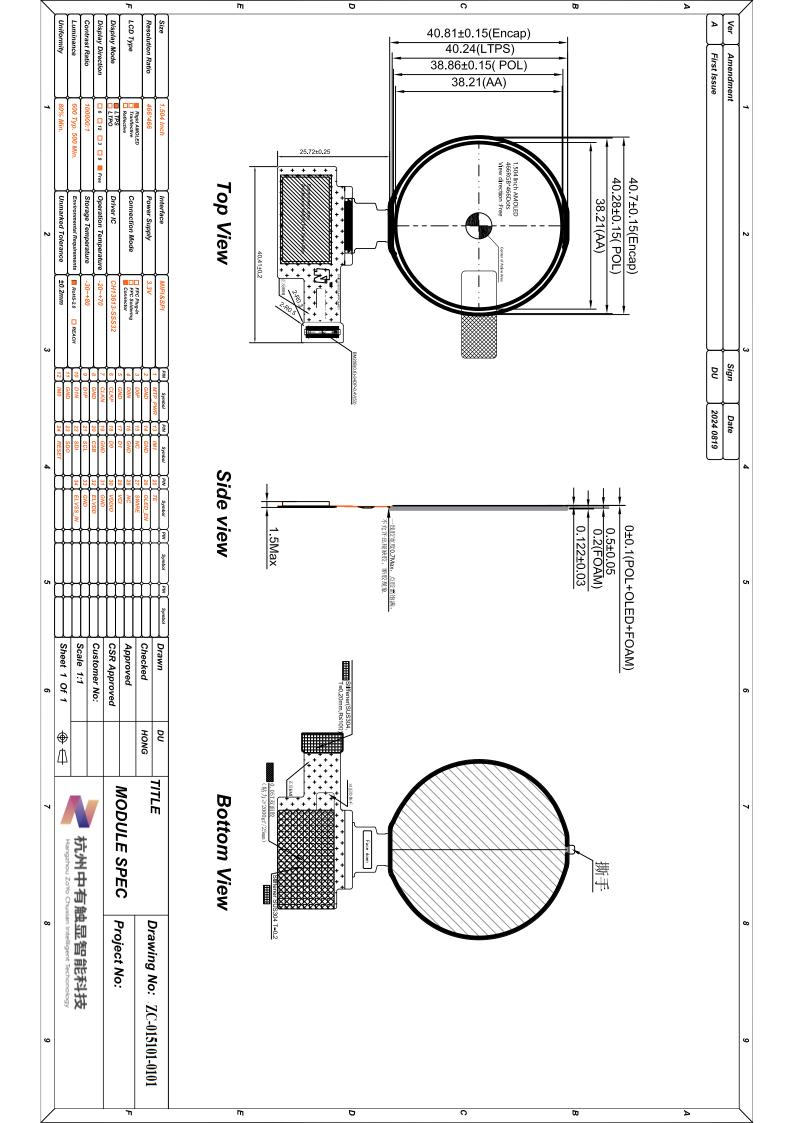


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3.BLOCK DIAGRAM:









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5. MAIN FPC PIN DESCRIPTION:

Pin	Symbol	1/0	Doscription	Not
No.	Syllibol	1/0	Description	e.
1	MTP_ PWR	Р	OTP Panel.	
2	GND	Р	Ground.	
3	D0P	I	MIPI DSI Positive differential data signal.	
4	D0N	l	MIPI DSI Negative differential data signal.	
5	GND	Р	Ground.	
6	CLKP	I	MIPI DSI Positive clock signal.	
7	CLKN	ı	MIPI DSI Negative clock signal.	
8	GND	Р	Ground.	
9	D1P	ı	MIPI DSI Positive differential data signal.	
10	D1N	ı	MIPI DSI Negative differential data signal.	
11	GND	Р	Ground.	
12	IM0	I/O	Interface type selection.	
13	IM1	I/O	Interface type selection.	
14	GND	Р	Ground.	
15	NC	-	No connection.	
16	GND	Р	Ground.	
17	D1	l	Serial input signal in SPI I/F. The data is input on the rising edge of the SCL signal. If not used, please connect to VSSIO.	
18	D0	l	Serial input signal in SPI I/F. The data is input on the rising edge of the SCL signal. If not used, please connect to VSSIO.	
19	GND	Р	Ground.	





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20	CSB	I	Chip select input pin in SPI I/F. If not used, please connect to VDDIO.	
21	SCL	I	Pixel clock input signal.	
22	SDI	I	Serial data input signal.	
23	SDO	I	Serial data output signal.	
24	RESE T		Reset signal input.	
			Tearing effect output pin to synchronize	
25	TE	0	MCU to frame writing, activated by S/W	
			command. When this pin is not activated, this pin is output low.	
	OLED		Power IC enable control pin (Note: "H" =	
26	_EN	Ο	VDDI level, "L" = VSSI level.	
27	SWIR E	0	Swire protocol setting pin of Power IC.	
28	NC	-	No connection.	
29	VCI	Р	Supply analog voltage.	
30	VDDIO	Р	Power supply for display driver IC interface and logic system.	
31	GND	Р	Ground.	
32	ELVDD	Р	Positive Power supply for Panel.	
33	GND	Р	Ground.	
34	ELVSS_I N	Р	Negative Power supply for Panel.	

Connector Name/Designation	Interface Connector/Interface Card
Type Part Number	BM20B(0.6)-34DP-0.4V(53)
Mating Housing Part Number	BM20B(0.6)-34DS-0.4V(53)

Note: I=Input; O=Output; P=Power; I/O=Input / Output





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6. <u>ELECTRICAL CHARACTERISTICS</u>

6.1 Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit	Remarks
Supply voltage	VDDA	-0.3	5.5	V	
Supply voltage	VDDIO	-0.3	5.5	V	
Supply voltage (MV)	AVDD-VSS	-0.3	6.6	V	
Supply voltage (IVIV)	AVEE-VSS	0.3	5.5	V	
	VGH-VSS	-0.3	15	V	
Supply voltage (HV)	VGL-VSS	0.3	15	V	
	VGH-VGL (VGHO-VGLO)	-0.3	32	V	
Logic Input voltage range	VIN	-0.3	1.45	V	5
Logic Output voltage range	VO	-0.3	0.3	V	

6.2 DC Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Uni
AMOLED Power positive	ELVDD	3.25	3.3	3.35	V
AMOLED power Negative	ELVSS	-3.25	-3.3	-3.35	V
Panel GEOA Power	VDD	5.8	6.0	6.2	V
Panel GEOA Power	VEE	-6.2	-6.0	-5.8	V
Panel Reference Power	VREFN		-3		V
Panel Reference Power	VREFP	-	3.3		V
Vdata voltage	VgammaH	_	5.2		V
Digital Power supply	IVDDIO	1.65	1.8	1.95	V
Display Analog Power supply	VCI	3.25	3.3	3.35	V
AMOLED Positive power positive Ripple	ELVDD	-	-	10	mA
AMOLED Negative power Negative Ripple	ELVSS	-	_	20	mA
Digital Power supply Ripple	VDDIO	-	=	20	mA
Analog Power supply Ripple	VCI	-	-	20	mA



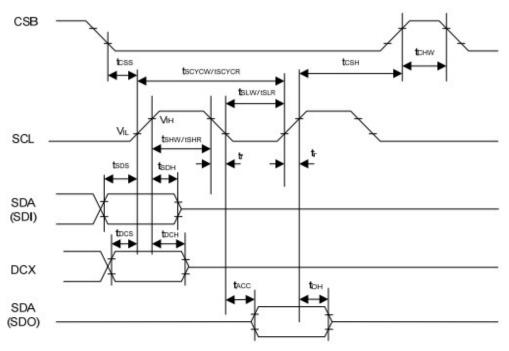


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6.3 AC Characteristics

6.3.1 8bit/9bit SPI Connect with Host Characteristics



Signal	Symbol	Parameter	Min.	Max.	Unit	Description
	t _{SCYCW}	Serial clock cycle (Write)	20	-	ns	10.00
SCL	tshw	SCL "H" pulse width (Write)	9	-	ns	
	tsuw	SCL "L" pulse width (Write)	9	1157.3	ns	
SUL	tscycR	Serial clock cycle (Read register)	300	-	ns	
	t _{SHR}	SCL "H" pulse width (Read register)	140		ns	
	tsur	SCL "L" pulse width (Read register)	140	15.1	ns	
	tsps/tpcs	Data setup time	5	-	ns	
SDI	tsph/tpch	Data hold time	5	-	ns	
(SDO) DCX	tacc	Access time	•	120	ns	
	tон	Output disable time	5	-	ns	
CSB	tonw	Chip select "H" pulse width	45	-	ns	
	tcss	Chip select setup time	10	-	ns	
	t _{CSH}	Chip select hold time	10	-	ns	

Note 1: VDDIO/VDDR =1.65 to 3.6V, VDDA/VDDB =2.7 to 3.6V, VSSIO=DVSS=VSSG=VSSAM=VSSR =VSSB=0V, Ta=-40 to +85 °C.





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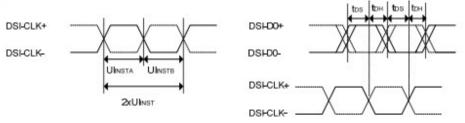
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6.3.2 MIPI DSI Timing Characteristics

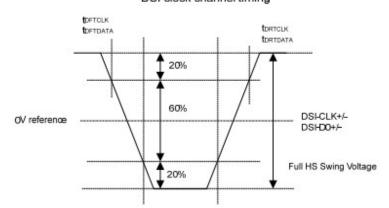
High Speed Mode

Signal	Symbol	Parameter	Min.	Тур.	Max.	Unit	Description
DSI-CLK+/-	2×UI _{INST}	Double UI instantaneous	4	-	TBD	ns	
DSI-CLK+/-	UI _{INSTA} UI _{INSTB}	UI instantaneous halves (UI = Ulinsta = Ulinsta)	2	C.	TBD	ns	
DSI-Dn+/-	tos	Data to dock setup time	0.15×UI	-		ps	
DSI-Dn+/-	tон	Data to clock hold time	0.15×UI	2	12 (6)	ps	
DSI-CLK+/-	t _{DRTCLK}	Differential rise time for clock	150	-	0.3×UI	ps	
DSI-Dn+/-	t _{DRTDATA}	Differential rise time for data	150	-	0.3×UI	ps	
DSI-CLK+/-	t _{DFTCLK}	Differential fall time for clock	150	2	0.3×UI	ps	
DSI-Dn+/-	toftdata.	Differential fall time for data	150	-	0.3×UI	ps	

Note 1: VDDIO/ VDDR = $1.65\sim3.6$ V, VDDA/VDDB=2.7 to 3.6V, VSSIO=DVSS=VSSG=VSSAM=VSSR =VSSB=0V, Ta=-40 to +85 °C. Note 2) Dn=D0 and D1.



DSI clock channel timing



Rising and falling time on clock and data channel





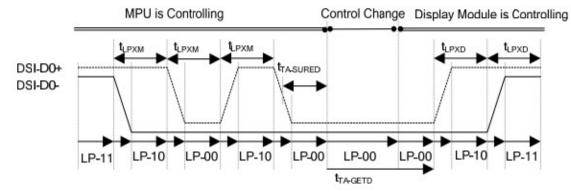
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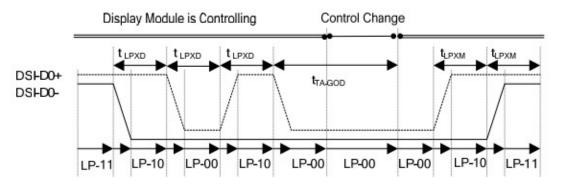
Low Power Mode

Signal	Symbol	Parameter	Min.	Тур.	Max.	Unit	Description
DSI-D0+/-	tLPXM	Length of LP-00, LP-01, LP-10 or LP-11 periods MPU → Display Module	50	-	75	ns	Input
DSI-D0+/-	t _{LPXD}	Length of LP-00, LP-01, LP-10 or LP-11 periods Display Module → MPU	50		75	ns	Output
DSI-D0+/-	t _{TA-SURED}	Time-out before the MPU start driving	t _{LPXD}	-	2×t _{LPXD}	ns	Output
DSI-D0+/-	t _{TA-GETD}	Time to drive LP-00 by display module	5×t _{LPXD}	-	-	ns	Input
DSI-D0+/-	t _{TA-GOD}	Time to drive LP-00 after turnaround request - MPU	4×t _{LPXD}	-	-	ns	Output

Note 1: VDDIO/ VDDR =1.65~3.6V, VDDA/VDDB=2.7 to 3.6V, VSSIO=DVSS=VSSG=VSSAM=VSSR =VSSB=0V, Ta=-40 to +85 °C.



Bus Turnaround (BAT) from MPU to display module Timing



Bus Turnaround (BAT) from display module to MPU Timing

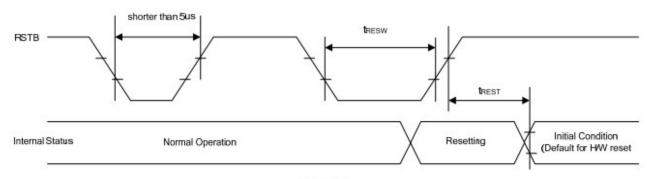




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6.3.3 Display RESET Timing Characteristics



Reset input timing

Signal	Symbol	Parameter	Min.	Тур.	Max.	Unit	Description
	tRESW	Reset "L" pulse width (Note 1)	10	154	100	μs	
RSTB	tREST	Reset complete time	-	(-)(10	ms	When reset applied during Sleep In Mode
	IRESI	(Note 2)			120	ms	When reset applied during Sleep Out Mode

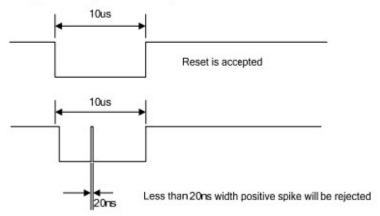
Note 1: Spike due to an electrostatic discharge on RSTB line does not cause irregular system Reset according to the table below.

RSTB Pulse	Action	
Shorter than 5µs	Reset Rejected	
Longer than 10µs	Reset	
Between 5µs and 10µs	Reset Start	

Note 2: During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out -mode. The display remains the blank state in Sleep In-mode) and then return to Default condition for H/W Reset.

Note 3: During Reset Complete Time, values in OTP memory will be latched to internal register during this period. This loading is done every time when there is H/W Reset complete time (t_{REST}) within 5ms after a rising edge of RSTB.

Note 4: Spike Rejection also applies during a valid Reset pulse as shown below:



Note 5: It is necessary to wait 5msec after releasing RSTB before sending commands. Also Sleep Out command cannot be sent for 120msec.





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7. RECOMMENDED OPERATING SEQUENCE

7.1 Display Power on / off Sequence

7.1.1 Power on sequence

The Power on sequence has been applied following Fig1, otherwise correct functionality is not guaranteed.

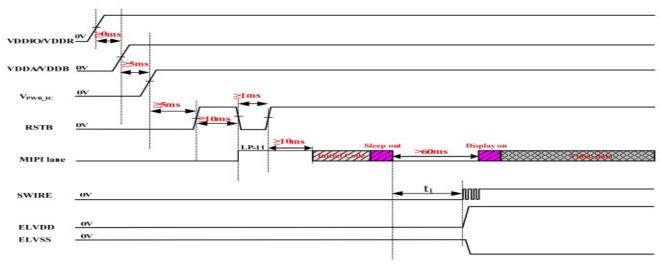


Fig 1 Power on sequence

Note1: t1 is ELVDD/ELVSS set up time, is controlled by SWIRE_ONF[5:0]; Note3: V_{PWR_IC} is the power of Power IC for ELVDD/ELVSS;

7.1.2 Power off sequence

The Power off sequence have been applied following Fig2, otherwise correct functionality is not guaranteed.

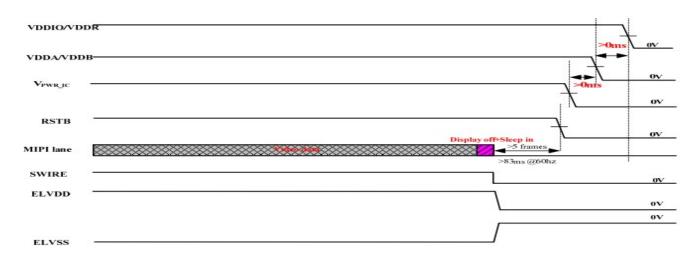


Fig 2 Power off sequence

Note1: VPWR_IC is the power of Power IC for ELVDD/ELVSS;





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9. OPTICAL CHARACTERISTICS

The test of optical specifications shall be measured in a dark room (ambient luminance 1 lux and temperature = 25 2° C) with the equipment of the Luminance meter system (Goniometer system and TOPCON BM-5) and the test unit shall be located at an approximate distance 50cm from the LCD surface at a viewing angle of θ and Φ equal to 0 . We refer to $\theta = 0 = 0 = 0$ (and $\theta = 0$) as the 3 o'clock direction (the "right"), $\theta = 0$ (and $\theta = 0$) as the 12 o'clock direction ("upward"), $\theta = 0$ (and $\theta = 0$) as the 9 o'clock direction ("left") and $\theta = 0$ (and $\theta = 0$) as the 6 o'clock direction ("bottom"). While scanning $\theta = 0$ and/or $\theta = 0$, the center of the measuring spot on the display surface shall stay fixed.

Item	Symbol	Condition	Min	Тур.	Max	Unit	Note
	θL		80			deg	Note 1
Viewing Angle	Θ_R	Cr≥10	80				
Viewing Angle	Ψτ	CIZIO	80				
	Ψв		80				
Contrast Ratio	Cr	θ=0°	100000	22		127	Based on
Response Time	Tr+Tf	FF=0°		2	4	ms	Note 3
	Wx		0.277	0.297	0.317		Note 4
	Wy		0.290	0.310	0.330		
	Rx		0.656	0.686	0.716		
Color Coordinate of	Ry	θ=0°	0.281	0.311	0.341		
CIE1931	Gx	0-0	0.185	0.235	0.285		
	Gy]	0.670	0.720	0.770		
	Bx	1	0.113	0.143	0.173		
	Ву	1	0.014	0.143	0.074		
Uniformity	U		80			%	
Color Gamut			9	108		%	Note 5
OLED Lifetime		200nit T95	Т9	5>=200	Oh		

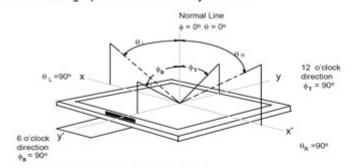




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Note 1:The definition of Viewing Angle Refer to the graph below marked by θ and ϕ .



Note2:ThedefinitionofContrastRatio

(Contrast Ratio is measured in optimum common electrode voltage)

Note3:DefinitionofResponse time.(Test LCD using RD80S or similar equipments):

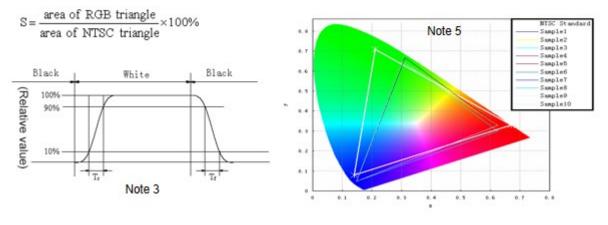
The output sign also photo detector are measured when the input sign also are changed from "black" to "white" (Voltage falling time) and from "white" to "black" (Voltage rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figures below.

Note 4: Color Coordinates of CIE 1931

The test condition is at ILED=20mA and measured on the surface of LCD module at 25°C. Measurement equipment:CS2000 or similar equipments

The Color Coordinate (CIE 1931) is the measurement of the center of the display shown in below figure.

Note 5: Definition of Color of CIE Coordinate and NTSC Ratio.







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10. PACKAGE

TBD





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11. STANDARD SPECIFICATION FOR RELIABILITY:

No	Test Items	Conditions	Testing standard
1	High temperature storage Test	Ta=+80°C, 128 hours	IEC60068-2-1:2007 GB2423.2-2008
2	Low temperature storage Test	Ta=-30°C, 128 hours	IEC60068-2-1:2007 GB2423.1-2008
3	High temperature operation Test	Ta=+70°C, 128 hours	IEC60068-2-1:2007 GB2423.2-2008
4	Low temperature operation Test	Ta=-20°C, 128 hours	IEC60068-2-1:2007 GB2423.1-2008
5	High temperature & humidity (storage Test)	Ta=+60°C, 90%RH max, 128 hours	IEC60068-2-78:2001 GB/T2423.3-2006
6	Thermal shock Test	-40°C 30min~85°C 30min, Change time:=0.5h/cycle,50cycle	Start with cold temperature End with high temperature IEC60068-2- 14:1984,GB2423.22-2002

12. QUALITY LEVEL

12.1 AMOLED Module of Characteristic Inspection

The environmental condition and visual inspection shall be conducted as below:

12.1.1 Test conditions:

OLED is not light, cold white fluorescent lamp, illumination 1000 ± 200 lux; OLED lighting source shall not be higher than 200lux, with black background around.

12.1.2 Inspection distance:

the standard observation distance of all surfaces of the tested object is $30 \text{cm} \pm 5 \text{cm}$.

12.1.3 Inspection angle:

the angle between the product and the horizontal plane is 45 °, and the eyes are perpendicular to the inspection plane. During inspection, the product needs to rotate 45 ° up, down, left and right. The observation line of sight needs to be within the half section of the cone. The observation angle is 45 ° with the vertical axis of the product apex. The central axis of the cone must be standard and perpendicular to the product surface and pass through the fluorescent lamp; For non-conventional display defects (including but not limited to local bright lines or local floodlights), the observation angle is 75 degrees from the normal of the product surface; Full visual angle of appearance.

12.1.4 Inspection time:

the inspection time without lighting is at least 10-12 seconds; The time of OLED lighting inspection for each picture is 1~3 seconds. If the defect is still not visible within the specified time, the inspection





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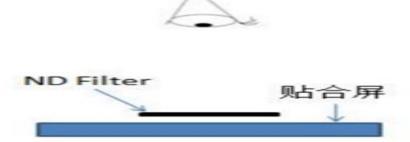
piece is deemed to be qualified.

12.1.5 Test temperature: room temperature 15-35 °C, ambient humidity: 20-75% RH.

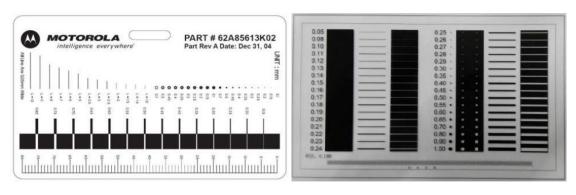
12.1.6 Inspection tools:

12.1.6.1 ND Filter:

The ND Filter is placed at a distance of 2-3 cm above the defect for 2-3s to judge whether the defect is visible. As Figure below: (ND Filter is used to test mura isochromatic and light unevenness)



12.1.6.2 Point gauge (point gauge in the figure below is recommended), determination method: as shown in the figure, the point gauge film can cover is pass, and the point gauge film can not cover is Fail. For example, a maximum of 0.2mm same-color spot defect is allowed on the Class A surface, and the pass that can be covered by 0.2mm on the film. The one that can be covered is Fail.





Imperfections of various shapes



Inspection Dot



Pass: Imperfection is smaller than the inspection dot



Fail: Imperfection is larger than the inspection dot

- 12.1.6.3 Microscopic examination: use 20-50 times adjustable microscope and 10-30 times test eyepiece.
- 12.1.6.4 Digital caliper: resolution 0.01mm.
- 12.1.6.5 Projector: anime microscope, 3D projector.





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12.1.6.6 Judgment description:

12.1.6.6.1 The measurement accuracy shall refer to the specification definition. When the measurement equipment accuracy is higher than the specification definition, the measured value needs to be rounded to the precision defined by the specification the. For example, the size of edge collapse is 0.20mm, and the thousandth is the reference position, which is rounded to 0.200mm~0.204mm is OK,>=0.205mm, it is judged as NG.

12.1.6.6.2 In addition to the tools used above, if additional inspection tools are needed to assist the judgment, they can only be carried out after the coordination of both parties.

12.1.6.6.3 Bad code and definition

Cod	de and name	legend	explain
N	Number	-	Visually calculate the number; The statistics of the total number of defects does not include the completely "omitted" part. For the column defined as "omitted" and "omitted", it is not counted as the number of defects if it meets the requirements, otherwise it is calculated as an independent defect.
L	Length (mm)		Dot line distinguishing rule: L is the long side, W is the short side A. When L > 3W, handle as per line, otherwise
W	Width (mm)		handle as per point; B. When it is judged as line defect, S-shaped or C-shaped line appears, and the enclosed amount is less than 3/4 circle, it shall be treated as line defect; otherwise, it shall be treated as point defect, and the inner tangent circle shall simulate the size of point.
S	Area (mm2)	-	Surface gauge
D	Diameter (mm) D=(L+W)/2	-	Point diameter calculation: calculated by half of the sum of the long side and the short side, that is,





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			D=(L+W)/2, where D represents the diameter of the
			point, L is the long side, and W is the short side;
Н	Depth (mm)	-	Digital micrometer
DS	Distance (mm)	DS DS	Distance between two points or between two lines
200 800	- 40 HB-00	AAK	AA area: display area;
	matic diagram	K.	GA area: GIP circuit area;
of s	creen area	FAIX	FA area: Frit area;
		■ × ×	OA area: outside FA area
Leader area			Screen GIP circuit area, screen data circuit area
PAD Bangding District			COG/FOG Bonding alignment mark and Bonding Pad on LTPS substrate
PAD Non-state area			Screen test pad, cutting area and lead-free area on LTPS substrate
CT crimping area			Pin end screen test pad





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Highlights	等于1/2子香蕉IDS	A single sub-pixel (or red, or green, or blue) of one pixel is called a point; The definition of bright spot is that in the environment of 200 ± 50 Lux, the pixels or dots seen by employees with naked eyes are always bright, and the bright spot is checked under the black screen
Scotoma	单个镜点	A single sub-pixel (or red, or green, or blue) of one pixel is called a point; A dark point is defined as a point that is not bright in a single sub-pixel seen with naked eyes in a 100% white picture under the environment of 200 ±50 Lux.
Dark spot - two connection	暗点-二连接	Two adjacent sub-pixels under the magnifying glass are not bright at the same time (horizontal, vertical and oblique)
Dark Spot - Three Links	職点三连接	The adjacent R, G and B sub-pixels under the magnifying glass are not bright at the same time (horizontal, vertical and oblique)
CG monomer area division	Sin Ind Till Sin Ind Till	AA: Front visible area, black ink internal area; A: Black ink area; B: Cover plate edge; The front defect that runs through the AA area and the A area shall be judged according to the specification of the strictest area, and the back defect shall be judged according to whether the AA area is visible.
Foreign matter highlights	-	Due to the foreign matter in the polarizer, the phenomenon that appears as a bright spot is called a foreign matter bright spot





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	There are bright spots and black spots in local
	positions, including but not limited to the internal
	dirt of the screen itself, pinholes, serrations,
W. W.	concave-convex spots, color spots, tiny bubbles,
\bigcirc_{+}	white spots, stains on the fitting of the polarizer,
	poor polarizer itself and other spot-like defects.
	Point defects are judged by diameter.
-	Linear impurities in the screen, including filaments,
	fibers, polarizer fitting impurities in the screen, and
	scratches on the surface of polarizer, etc. Linear
	defects are judged by length and width.
	Sensible scratch: also known as hard scratch, is a
J. W	deep scratch on the surface, which is felt by hand.
	Senseless scratch: also known as fine scratch, no
	deep scratch on the surface, no feeling when
	touching.
	todorning.
	W: Distance from sawtooth crest to trough
	In the process of screen production, especially in
	the process of molding and cutting, the small glass
X+	missing at the glass edge is caused.
W. T.	X direction: parallel to FOG Pad or glass edge;
	Y direction: perpendicular to FOG Pad or glass
2. 1	edge;
	Z direction: screen thickness direction;
	T : The thickness of single-layer glass;
	In the unit area of 10mm * 10mm, the defect point
	with D ≤ 0.1mm, DS ≥ 2mm, and the number N ≥ 5.
n=0	If the customer has other requirements, follow the
	if the customer has other requirements, follow the
	L W W





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Dirty	Including handprints, oil stains, fingerprints, stains, white fog and other undesirable phenomena. It is divided into erasable dirt and non-erasable dirt. Use a dust-free cloth dipped in alcohol, which can not be erased as non-erasable dirt. Wipable dirt is determined as follows: A. Dry dust-free cloth can be directly erased; B. Wipe with clean cloth dipped with anhydrous alcohol Press the alcohol-stained dust-free cloth on the dry
	dust-free cloth twice to absorb excess alcohol; Wipe back and forth with a dust-free cloth twice, and the dirt can be removed.

12.2 Sampling Procedures for Each Item Acceptance Table

Critical Defect (CR): any defect that directly or indirectly affects human health and safety, or the function of the product is lost.

Major Defect (MA): directly or indirectly affect the product function, or make part of the product function lost, and other customers do not acceptable defects.

Minor Defect (MI): appearance defect that does not affect product function and can be accepted by customers.

Defect Type Sampling Procedures		AQL
Critical Defect (CR)	Take the normal inspection solution of the sampling plan of GB/T2828.1-2012 Inspection levelⅡ	0.065
Major Defect (MA)	Take the normal inspection solution of the sampling plan of GB/T2828.1-2012 Inspection level	0.65
Minor Defect (MI)	Take the normal inspection solution of the sampling plan of GB/T2828.1-2012 Inspection level Ⅱ	1.0

12.3 Telecommunications Inspection Item

category	NO.	Inspection items	Inspection specification	test mode	defect type
	1	Display exception	not allow	visual	CR





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Poor	2	No display	not allow	visual	CR
function	3	The picture flickers	not allow	visual	MA
TP function	4	TP test NG	not allow	visual	MA
	5	Bright dot	not allow	visual	MI
	6	Partial Bright dot	ND6% or reference limit sample	visual	MI
Dot	7	Dark dot	1.D≤0.15mm, ignored; 2.0.15mm < D≤ 0.2mm, DS ≥ 10mm, N ≤ 10; 3.D > 0.2mm,not allowed;	Visual inspection, Flinka	MI
	8	Bright line	not allow	visual	MA
Line	9	Dark line	not allow	visual	MA
	10	Slightly bright line	not allow	visual visual visual visual visual inspection, Flinka visual	MA
	11	horizontal mura	No control under W64/127 screen; The 4%ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	ND Filter/limit	MI
	12	vertical mura	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	ND Filter/limit	MI
Mura	13	White spot	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	ND Filter/limit	MI
	14	Black spot	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	ND Filter/limit	МІ
	15	Color mura	4% ND Filter in W64/255 screen determines that the invisible is OK and the visible is NG	ND Filter/limit	MI





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	16	snowflake	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	МІ
	17	Twill mura	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	МІ
	18	Newtonian ring	No control under W64/127 screen; The 4% ND Filter on the 255 screen determines that the invisible is OK and the visible is NG.	Visual ND Filter/limit sample	МІ
	19	Uneven transition	Reference homogeneity standard to assist in judgment; The 4% ND Filter in the W64/255 screen determines that the invisible product is OK and the visible product is NG.	Visual ND Filter/limit sample	МІ
			n judgment. For example, if the ira will only be judged on the W		ent
	to the		a low adverse effect rate and lo 64/255 screen, the invisible pro		
Dot/line of foreign material	20	Dot/line defects (foreign material, black white dot, scratch, bubble, etc.)	Same point/line specifications	Visual inspection/Fli nka	MI

12.4 Appearance Inspection Item

NO.	Inspection	Surfac e Area	Inspection specification	test mode	defect type
1	Broken glass	AA/OA	not allow	visual	MA
2	crack	AA/OA	not allow	visual	MA
3	Edge collapse/cor ner	AA/OA	 Y ≤ 0.15mm, X and N are ignored; 0.15 < Y ≤ 0.4mm, X ≤ 2mm, N is ignored; Y > 0.4mm, not allowed; Z ≤ t, without damage to Frit body; 	Visual inspection, Flinka	MI





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			X. T.		
4	flange	AA/OA	1. Y ≤ 0.2mm, X is uncontrolled; 2. Y > 0.2mm, not allowed;	Visual inspection, Flinka	МІ
5	Glass warp	Whole area	The product is placed horizontally on the front and back, and the lifting height at one end (plug gauge) ≤ 0.6mm	Visual inspection, Flinka	МІ
6	Pin dirty	Bongdi ng area	No control	visual	MI
7	Pin scratch	Bongdi ng area	Scratches and whitening are found by visual inspection, and need to be rechecked with a microscope. The broken lead is not allowed, and the overlap is not allowed Note: CT pad area and pin non-bonding area are not controlled	visual	МІ
8	PF film bump	LTPS	Touch is not allowed	visual	МІ
9	PF film pinholes/pit s	LTPS	No control	visual	МІ
10	PF film scratch	LTPS	 No scratch, no control; Scrape through, L<10mm; The film shall be scraped through the exposed glass surface, referring to the lack of glue of PF film; 	Visual inspection, Flinka	МІ
11	PF film lacks glue	LTPS	50> 5mm, W>5mm not allowed	Visual inspection, Flinka	МІ
12	PF membrane is dirty	LTPS	Wipable dirt needs to be wiped, and non-wipe dirt refers to the color difference of PF film;	visual	МІ
13	PF film overflow	LTPS	Edge overflow W<0.2mm, acceptable; W>0.2mm, not allowed;	Visual inspection, Flinka	МІ





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14	Color difference/st ain (no convex touch)	LTPS	No contro	ol					visual	МІ
15	PF film gluing offset	LTPS	controlle	t for	the step 0.5 ± 0.2	area, ti		est shall be	Visual inspection, Flinka	MI
16	Screen body is dirty	LTPS		nd e wi	the pola ped;	rizer of		dirt can be dirt cover	visual	MI
	3		D (mm	40.14	DS (r		Α	cceptable number	6) (0.0 (0.0) (0.0) (0.0)	
17	point defect	AA	D≤ 0.15mr	n	1			Ignore	Visual inspection,	MI
	10		0.15mm D≤0.2m	<	DS	≥10		N≤10	Flinka	
			(mm	L	(mm)	DS (mm		Acceptab le number		
	Linear defect/forei gn matter linear/non-		W≤ 0.03		L≤5	≥10)	ignore		
18			0.03< W≤ 0.05		L≤2	≥10	0	ignore	Visual inspection,	MI
	inductive scratch		0.03< W≤ 0.05	2	<l≤5< td=""><td>≥10</td><td>)</td><td>N≤4 Flinka</td><td>FIINKA</td><td></td></l≤5<>	≥10)	N≤4 Flinka	FIINKA	
			W>0.0 5		-	1		Not allowed		
			-		L>5	1		Not allowed		
3		Camer	D(mm)		D(mm) Acceptable number		le number			
19	Point/Line	a hole area/Bli	Ds	€0.1	5	ignore		ore	Visual	MI
19	defects	nd hole	0.15	<d≤< td=""><td>€0.2</td><td></td><td>ign</td><td>ore</td><td>inspection, Flinka</td><td>IVII</td></d≤<>	€0.2		ign	ore	inspection, Flinka	IVII
		area	D>0.2							
20	Newton rings (Blind hole area)	Camer a hole area/Bli nd hole area	Not contr	rol					Visual inspection	MI
21	offset	Camer a hole	The meta	al rin	g extend	s inward	0.1	mm ,ingore	Visual inspection	MI





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- 5		area/Bli	8	is s	
	2	nd hole area			
22	Blind hole color bias(same color)	Camer a hole area/Bli nd hole area	Functional requirements such as transmittance and PV value are met,not control appearance	Visual inspection	МІ
23	Protective film scratch	Whole area	No control under no hurt boby	Visual inspection	MI
24	Protective film starved/ove rflow glue/burr	Whole area	No control under no hurt boby	Visual inspection	МІ
25	Dirt inside the protective film	Whole area	Not allowed	Visual inspection	MI
26	Easy to tear	Cover front	Function is invalid, damaged, leaked not allowed Wrinkles, bumps, dirt, punching bad, burr, overflow glue is not controlled	Visual inspection	МІ
27	Polarizer edge overflow	AA	W≤0.35mm , Not control: W>0.35mm, Not allowed.	Visual inspection, Flinka	MI
28	Polarizer concave convex point	AA	convex point: D ≤ 0.2mm or refer to limit sample concave point: D≤3mm, DS≥10mm, N≤3 or refer to limit sample	Visual inspection, Flinka	МІ
29	Polarizer fold / indentation	AA	Does not affect the display as OK or refer to limit sample;	Visual inspection	MI
30	Polarizer chromatism	AA	No control	Visual inspection	MI
31	IC chip	IC	Not allowed	Visual inspection	МІ
32	FPC body defect	FPC	1. The parts on the FPC must be consistent with the product BOM table, and there are incorrect, multiple, or missing parts, which are not allowed; Polarities such as capacitors and inductors should not be soldered backwards or crooked; 2. FPC scratches/scratches are based on the absence of exposed copper; 3. Creases/Indentations: Indentations in the circuit area should not cause the back of the	Visual inspection	МІ





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			covering film to turn white; Non line area indentation should not cause FPC damage 4. Except for the golden finger. FPC foreign object: a. Spot shape: D ≤ 0.5mm, N ≤ 3; b. Linear: length and width ≤ 0.3 * 5mm;		
33	FPC gold finger defect	Golden Finger Region	 Golden finger cracking: The length and width of the crack/damage at the top of the golden finger ≤ the line width; Gold finger copper leakage: W ≤ 1/3 line width, L ≤ line width, unlimited quantity Gold finger gap W1 ≤ 1/3 line width W, length L1 ≤ 1/2 line width W, unlimited quantity, all of the above conditions are met and allowed; Gold finger pressure/scratch should not expose copper, there should be no unevenness, and there should be no depth visible to the naked eye, which does not affect assembly and is acceptable; Gold fingers should not have sharp creases or dead folds; FPC gold fingers should not have oxidation, blackening, burns, or browning; 	Visual inspection	MI
34	connector	connect	There should be no tin or residual solder beads on the connector, and there should be no tin connection on the connector pins; PIN deformation shall be controlled within 0.05mm; Does not affect the lighting function; Visual inspection of pin breakage, pin detachment, and deformation of the outer frame is not allowed;	Visual inspection	MI
35	Insulating tape	Bondin g area Compo nent area	There must be no obvious wrinkles or bubbles 1. Scratches and glue splashes are uncontrollable; 2. Do not wipe dirt or dirt; 3. The offset of the insulation tape should not exceed the edge of the product, and other requirements should be determined based on the drawing; 4. Burr edges, no control over glue overflow;	Visual inspection	MI





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36	Composite tape	All	 Damaged, incomplete, or missing labels are not allowed; It is not allowed for the composite tape to leak out of the edge of the screen body; Folding of composite tape, light leakage during assembly, or affecting assembly and thickness are not allowed; Damaged composite tape is not allowed; The size of the composite tape cutting defect does not meet the requirements of the drawing and cannot be controlled; Composite tape should not be wiped with dirt or foreign objects, and foreign objects should follow the dotted line standard; The burrs of the composite tape should not exceed the edge of the screen body, regardless of control; Composite adhesive tape with no control over glue splashes or overflow; Composite tape bubbles: D ≤ 5mm, N not included; Composite tape bumps: acute angle bumps D ≤ 0.3mm, N ≤ 3; Smooth concave convex points D ≤ 0.8mm, N ≤ 3; Composite tape foreign object (foreign object between copper foil and blue film): D ≤ 0.3mm, N ≤ 3; Edge sawtooth of composite tape: 0.5 * 3mm, N ≤ 3; The color difference of the protective film in the composite tape is not controlled; Copper foil indentation and dead bending in composite tape are not allowed, which does not affect assembly and thickness control; Or reference limit sample; No control of foreign objects/dents in copper foil in composite tape; 	Visual inspection	MI
37	OCA overflow	All	Not allowed within AA area; Externally visible: Control standard ≤ 0.15mm	Visual inspection	MI





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38	Sealing glue	Pin	 Broken adhesive is not allowed, and the circuit cannot be exposed. The thickness of the colloid shall not be higher than the POL surface. Bubble diameter<1mm. Other: According to the drawings and work instructions. 	Visual inspection	МІ
39	Conductive cloth	All	 Conductive cloth dirt: D ≤ 5mm, N ≤ 2; Conductive cloth bubbles: D ≤ 2mm, N ≤ 2; Conductive cloth foreign object: D ≤ 1mm, N ≤ 3; Folding of conductive fabric: N ≤ 2; 	Visual inspection	МІ
40	Copper foil	All	Copper foil sticking is not allowed to leak out of the edge of the screen body; Abnormal color of copper foil refers to standard samples/sealed samples, and damage is not allowed. Soft scratches on the surface are not controlled.	Visual inspection	МІ
41	QR code	QR code	It is not allowed to be unable to scan or difficult to scan (recognition can only be achieved after three consecutive scans), with a clear appearance, no blurring, missing printing, and other defects	Visual inspection	МІ
42	Package	Other	Products should put into the anti-static trays, with non-overlapping, and the trays should be staggered placed. Different products cannot be mixed into the same inner package. The package should not have obvious deformation or breakage .The printing labels type and quantity are correct. The package should have QC signature. ROHS label is needed if the product is under ROHS control.	visual	_
43	Boundary dimension NG	Other	It is not allowed to exceed the dimensional tolerance required by the specifications and drawings	Calipers, measuring instruments	-

12.5 Inspection picture library

Serial	picture	Picture name	Mainly judged as defective	remarks	
number	picture	ricture manie	mainly judged as delective	Telliaiks	





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-			<u> </u>
1	W_ GRAD(64) 64 gray scale	Point/line type, foreign matter point/line, mura type	1
2	W_GRAD(128) 128 gray scale	Point/line type, foreign matter point/line, mura type	1
3	WHITE white	Point/line type, foreign matter point/line, mura type	1
4	Black black	Bright spot, bright line, dark mura	1
5	RED red	Point type, line type, foreign matter point/line	1
6	GREEN green	Point type, line type, foreign matter point/line	1
7	BLUE blue	Point type, line type, foreign matter point/line	1

Note: The actual sequence and lock seconds of the screen can be adjusted according to the customer's requirements and the needs of the factory.





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13. PRECAUTIONS FOR USE OF AMOLED MODULES

- 13.1 Handling Precautions:
- 13.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from height.
- 13.1.2 Do not press down the screen or the adjoining areas too hard because the color tone may be shifted.
- 13.1.3 The polarizer covering the display surface of the AMOLED module is soft and easily scratched. Handle this polarizer carefully.
- 13.1.4 If the display surface is contaminated, blow on the surface and gently wipe it with a soft dry cloth. If it is still not completely clear, moisten the cloth with ethyl alcohol.
- 13.1.5 Solvents may damage the polarizer. Do not use water, ketone or aromatic solvents except ethyl alcohol.
 Do not attempt to disassemble the AMOLED Module.
- 13.1.6 If the logic circuit power is off, do not apply the input signals.
- 13.1.7 To prevent destruction from static electricity, be careful to maintain an optimum working environment.
- 13.1.8 Be sure to make yourself in contact with the ground when handling with the AMOLED Modules.
- 13.1.9 Tools required for assembly, such as soldering irons, must be properly ground.
- 13.1.10 To reduce the generation of static electricity, do not conduct assembly or other work under dry conditions.
- 13.1.11 To protect the display surface, the AMOLED Module is coated with a film. Be careful when peeling off this protective film, because static electricity may generate.
- 13.2 Storage Precautions:
- 13.2.1 When storing the AMOLED modules, be sure that they are not directly exposed to the sunlight or the light of fluorescent lamps.
- 13.2.2 The AMOLED modules should be stored under the storage temperature range. If the AMOLED modules will be stored for a long time, the recommended condition is: Temperature: 0°C~40°C Relatively humidity: ≤80%
- 13.2.3 The AMOLED modules should be stored in the room without acid, alkali or harmful gas.
- 13.3 Transportation Precautions:
- 13.3.1 The AMOLED modules should not be suffered from falling and violent shocking during transportation. Besides, excessive press, water, damp and sunshine, should be avoided.